

N-channel 80 V, 3.5 mΩ typ., 90 A STripFET™ F7 Power MOSFET in a TO-220 package

Datasheet - production data

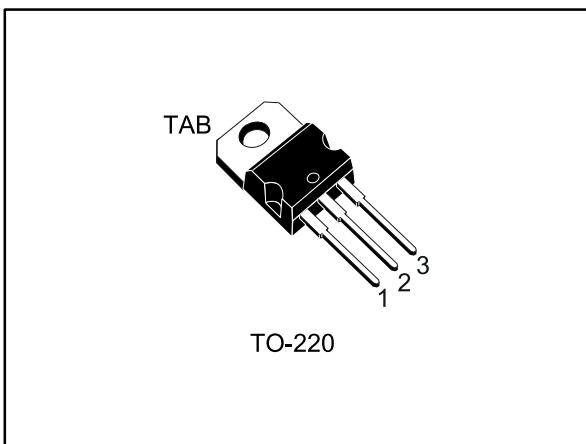
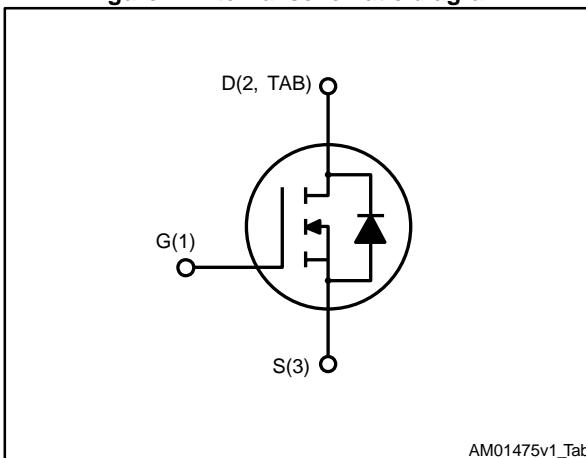


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	I _D	P _{TOT}
STP140N8F7	80 V	4.3 mΩ	90 A	200 W

- Among the lowest R_{DS(on)} on the market
- Excellent figure of merit (FoM)
- Low C_{rss}/C_{iss} ratio for EMI immunity
- High avalanche ruggedness

Applications

- Switching applications

Description

This N-channel Power MOSFET utilizes STripFET™ F7 technology with an enhanced trench gate structure that results in very low on-state resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.

Table 1: Device summary

Order code	Marking	Package	Packaging
STP140N8F7	140N8F7	TO-220	Tube

Contents

1	Electrical ratings	3
2	Electrical characteristics	4
2.1	Electrical characteristics (curves).....	6
3	Test circuits	8
4	Package mechanical data	9
4.1	TO-220 type A package information.....	10
5	Revision history	12

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage	80	V
V_{GS}	Gate-source voltage	± 20	V
I_D	Drain current (continuous) at $T_C = 25^\circ C$	90 ⁽¹⁾	A
I_D	Drain current (continuous) at $T_C = 100^\circ C$	90	A
$I_{DM}^{(2)}$	Drain current (pulsed)	360	A
P_{TOT}	Total dissipation at $T_C = 25^\circ C$	200	W
$E_{AS}^{(3)}$	Single pulse avalanche energy	515	mJ
T_j	Operating junction temperature	- 55 to 175	$^\circ C$
T_{stg}	Storage temperature		

Notes:

(1)Limited by package

(2)Pulse width is limited by safe operating area

(3)Starting $T_j = 25^\circ C$, $I_d = 18.5 A$, $V_{dd} = 50 V$ **Table 3: Thermal data**

Symbol	Parameter	Value	Unit
$R_{thj-case}$	Thermal resistance junction-case	0.75	$^\circ C/W$
$R_{thj-amb}$	thermal resistance junction-ambient	62.5	$^\circ C/W$

2 Electrical characteristics

($T_{CASE} = 25^\circ C$ unless otherwise specified)

Table 4: On/off states

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0, I_D = 250 \mu A$	80			V
I_{DSS}	Zero gate voltage Drain current	$V_{GS} = 0, V_{DS} = 80 V$			1	μA
		$V_{GS} = 0, V_{DS} = 80 V, T_J = 125^\circ C$			10	μA
I_{GSS}	Gate-source leakage current	$V_{DS} = 0, V_{GS} = \pm 20 V$			± 100	nA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.5		4.5	V
$R_{DS(on)}$	Static drain-source on-resistance	$V_{GS} = 10 V, I_D = 45 A$		3.5	4.3	$m\Omega$

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{iss}	Input capacitance	$V_{GS} = 0, V_{DS} = 40 V, f = 1$ MHz	-	6340	-	pF
C_{oss}	Output capacitance		-	1195	-	pF
C_{rss}	Reverse transfer capacitance		-	105	-	pF
Q_g	Total gate charge	$V_{DD} = 40 V, I_D = 64 A,$ $V_{GS} = 10 V$	-	96	-	nC
Q_{gs}	Gate-source charge		-	30	-	nC
Q_{gd}	Gate-drain charge		-	26	-	nC

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 40 V, I_D = 45 A, R_G = 4.7 \Omega, V_{GS} = 10 V$	-	26	-	ns
t_r	Rise time		-	51	-	ns
$t_{d(off)}$	Turn-off-delay time		-	82	-	ns
t_f	Fall time		-	44	-	ns

Table 7: Source drain diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I_{SD}	Source-drain current		-		90	A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)		-		360	A
$V_{SD}^{(2)}$	Forward on voltage	$V_{GS} = 0$, $I_{SD} = 90$ A	-		1.2	V
t_{rr}	Reverse recovery time	$I_{SD} = 64$ A, $dI/dt = 100$ A/ μ s,	-	58		ns
Q_{rr}	Reverse recovery charge	$V_{DD} = 60$ V	-	92		nC
I_{RRM}	Reverse recovery current	$T_j = 150$ °C	-	3.2		A

Notes:

(1)Pulse width is limited by safe operating area

(2)Pulse test: pulse duration = 300 μ s, duty cycle 1.5%

2.1 Electrical characteristics (curves)

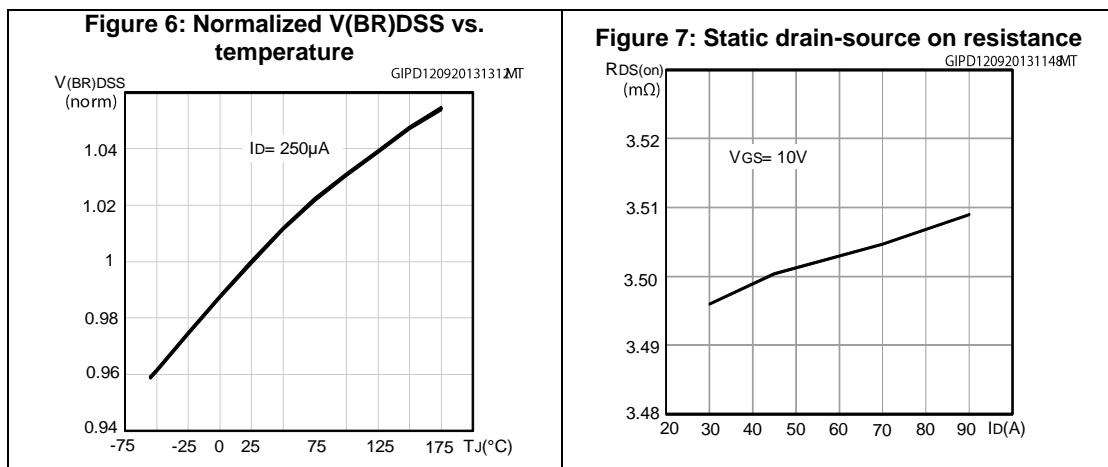
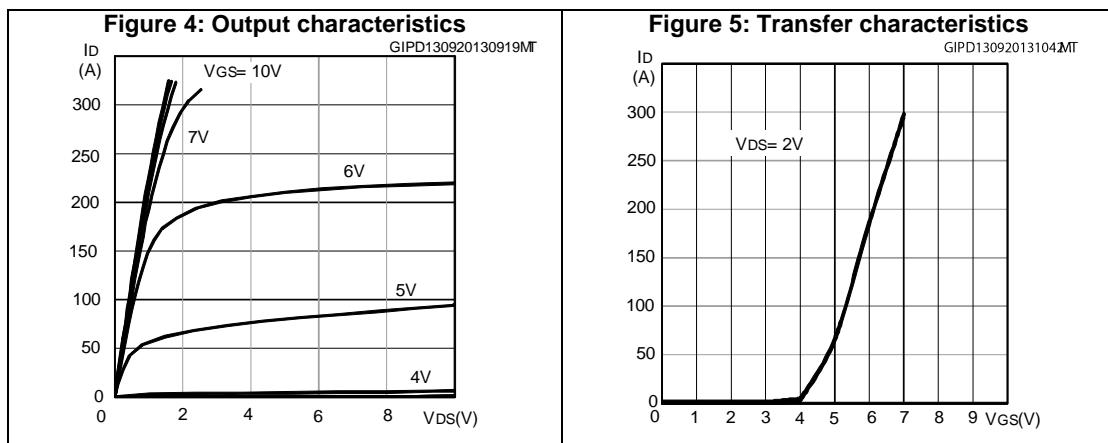
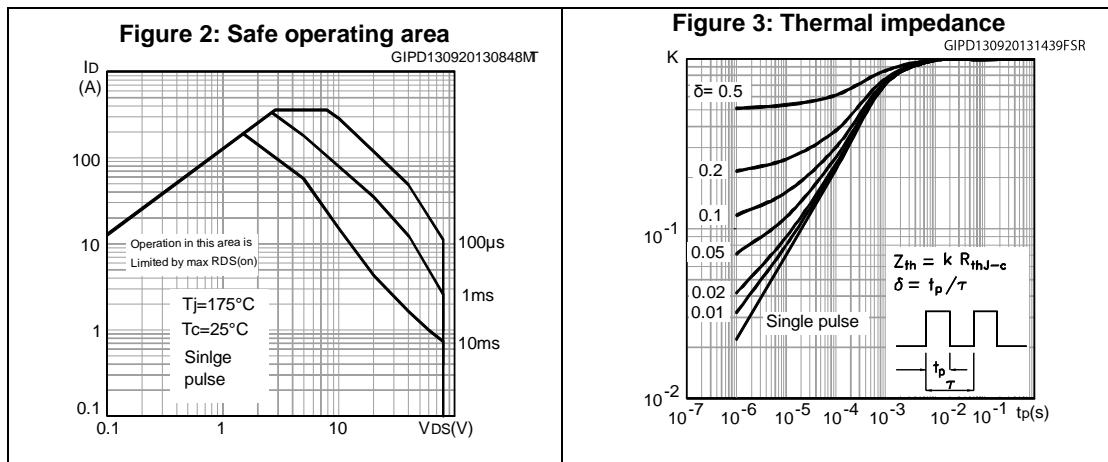
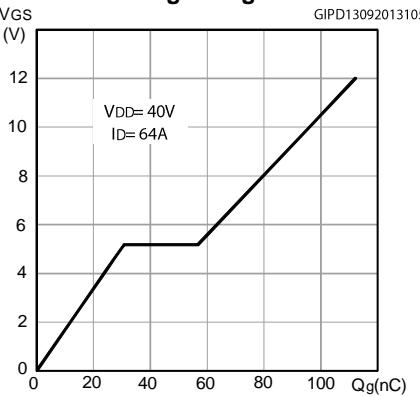
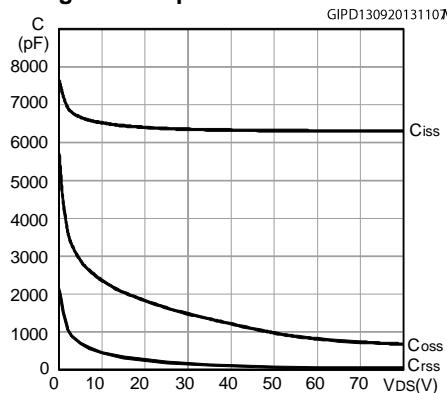
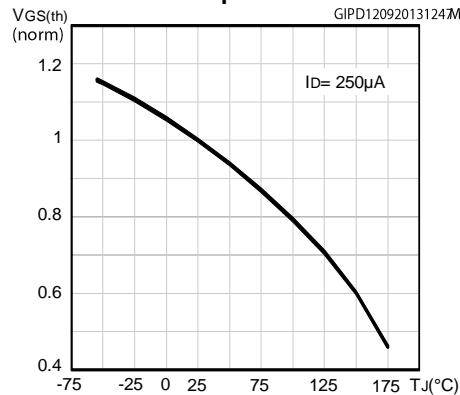
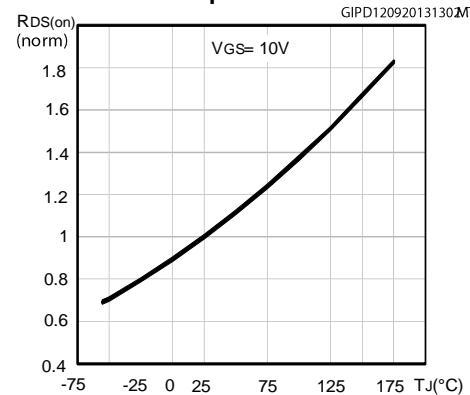
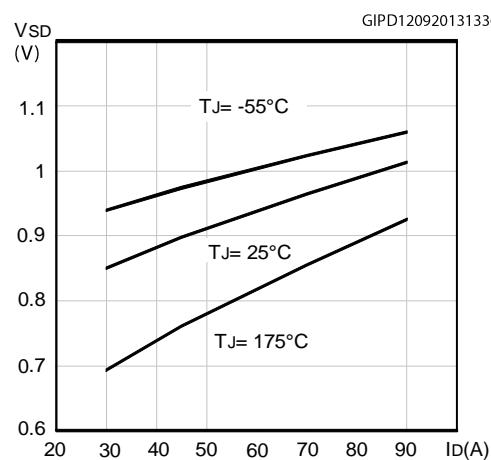
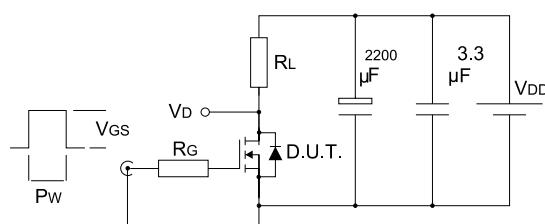


Figure 8: Gate charge vs. gate-source voltage**Figure 9: Capacitance variations****Figure 10: Normalized gate threshold voltage vs. temperature****Figure 11: Normalized on resistance vs. temperature****Figure 12: Source-drain diode forward characteristics**

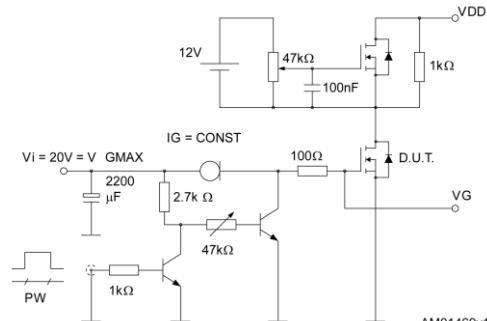
3 Test circuits

Figure 13: Switching times test circuit for resistive load



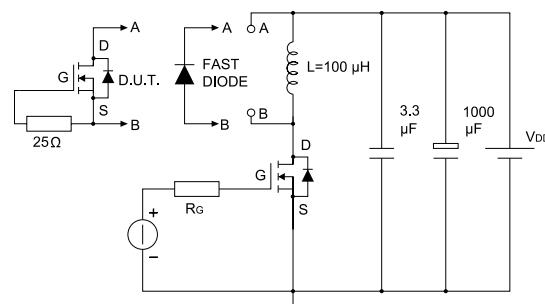
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Figure 14: Gate charge test circuit



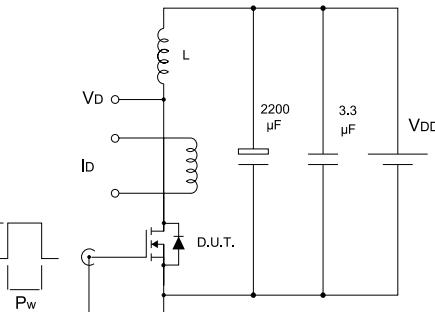
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Figure 15: Test circuit for inductive load switching and diode recovery times



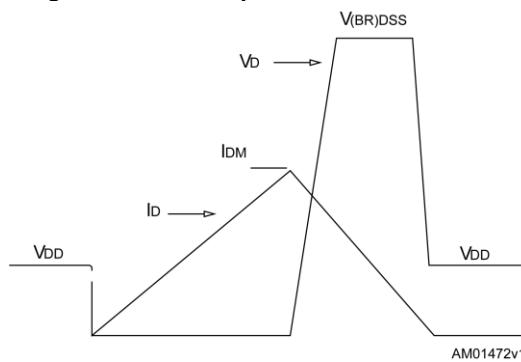
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Figure 16: Unclamped inductive load test circuit



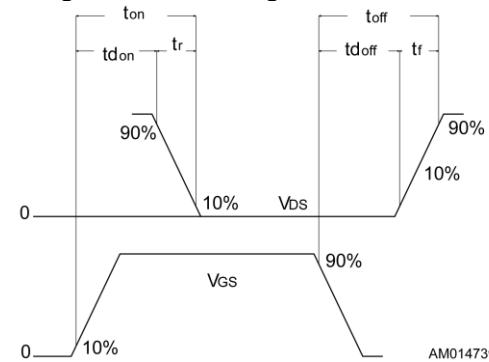
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Figure 17: Unclamped inductive waveform



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Figure 18: Switching time waveform



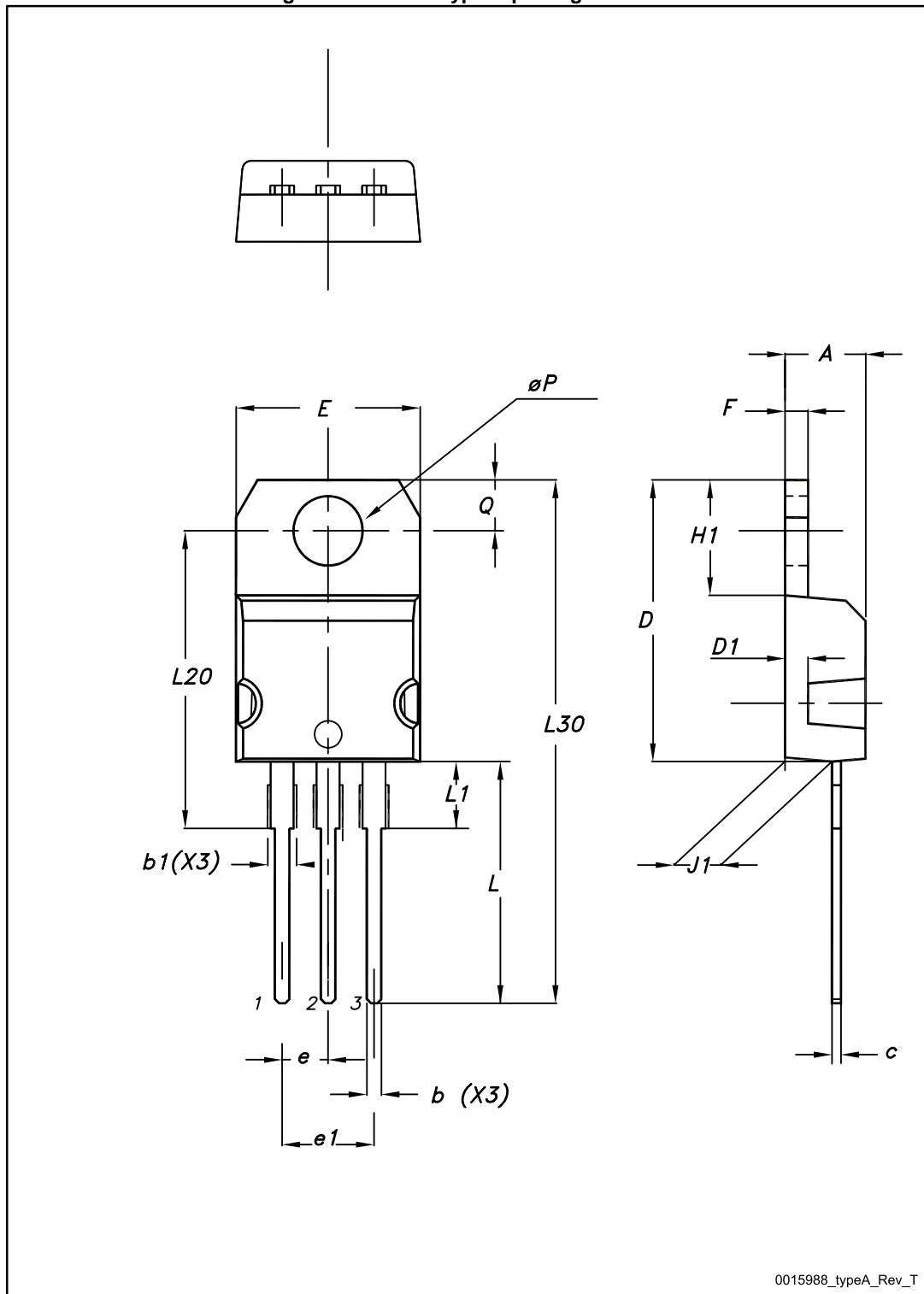
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4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com.
ECOPACK® is an ST trademark.

4.1 TO-220 type A package information

Figure 19: TO-220 type A package outline



0015988_typeA_Rev_T

Table 8: TO-220 type A mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
c	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10		10.40
e	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
ÆP	3.75		3.85
Q	2.65		2.95

5 Revision history

Table 9: Document revision history

Date	Revision	Changes
25-Aug-2014	1	First release.
09-Oct-2014	2	Updated Figure 3: "Thermal impedance"

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